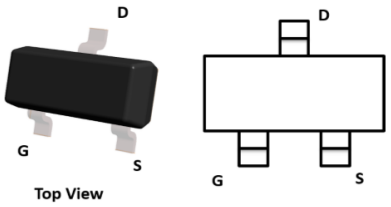
Features

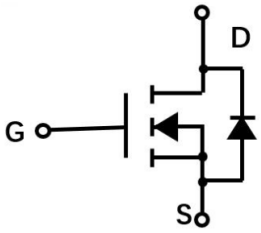
- 100V, 3.2A
- $R_{DS(ON)}$ = 130mΩ (Max.) @ V_{GS} = 10V, I_D = 3A
- High Power and Current Handing Capability
- Lead Free Product is Acquired
- Surface Mount Package

Application

- PWM Application
- Load Switch
- Power Management

Package





SOT-23
SEY9582AG

Absolute Maximum Ratings T_C=25℃ unless otherwise specified

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		100	V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D	Continuous Drain Current note5	T_C = 25℃	3.2	A
I_D	Continuous Drain Current note5	T_C = 100℃	2.0	A
I_{DM}	Pulsed Drain Current note3		19.6	A
P_D	Power Dissipation note2	T_C = 25℃	3.6	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient note1,4		85	℃/W
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	℃

Electrical Characteristics T_C=25℃ unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	100	-	-	V
I_{DSS}	Drain-Source Leakage Current	V_{DS} = 80V, V_{GS} = 0V	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	1.2	1.8	2.6	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10V, I_D =3A	-	105	130	mΩ
		V_{GS} = 4.5V, I_D = 2A	-	135	150	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 50V, V_{GS} = 0V, f = 1.0MHz	-	212	-	pF
C_{oss}	Output Capacitance		-	27.5	-	pF
C_{rss}	Reverse Transfer Capacitance		-	1.6	-	pF
Switching Characteristics						
Q_g	Total Gate Charge	V_{DS}= 50V, I_D = 3A, V_{GS} = 10V	-	3.3	-	nC
Q_{gs}	Gate-Source Charge		-	0.35	-	
Q_{gd}	Gate-Drain(“Miller”) Charge		-	0.87	-	
$t_{d(on)}$	Turn-On Delay Time	V_{DS} = 50V, I_D = 3A, R_G = 2Ω, V_{GS}=10V	-	13.2	-	ns
t_r	Turn-On Rise Time		-	2.2	-	
$t_{d(off)}$	Turn-Off Delay Time		-	11	-	
t_f	Turn-Off Fall Time		-	1.1	-	
Diode Characteristics						
I_S	Continuous Source Current		-	-	4.9	A
V_{SD}	Diode Forward Voltage	I_S=3A . V_{GS} = 0V	-	-	1.0	V
t_{rr}	Reverse Recovery Time	I_{SD}=3A, dI_{SD}/dt=100A/μs	-	27	-	ns
Q_{rr}	Reverse Recovery Charge		-	35	-	nC

Notes:

1. The value of $R_{\theta JC}$ is measured in a still air environment with TA =25°C and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

2. The power dissipation P_D is based on $T_{J(MAX)}$=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

3. Single pulse width limited by junction temperature $T_{J(MAX)}$=150°C.

4. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.

5. The maximum current rating is package limited.

Typical Performance Characteristics

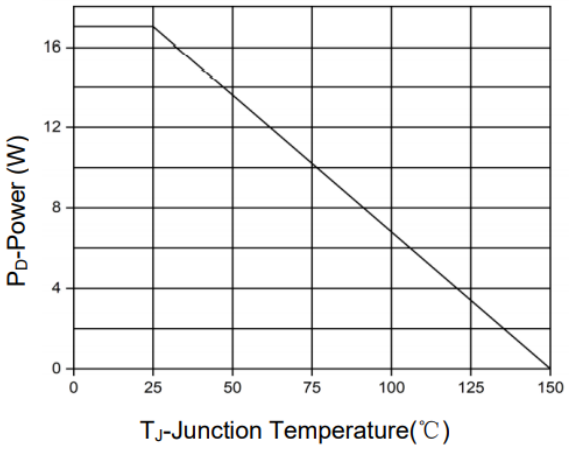


Figure 1. Power Dissipation

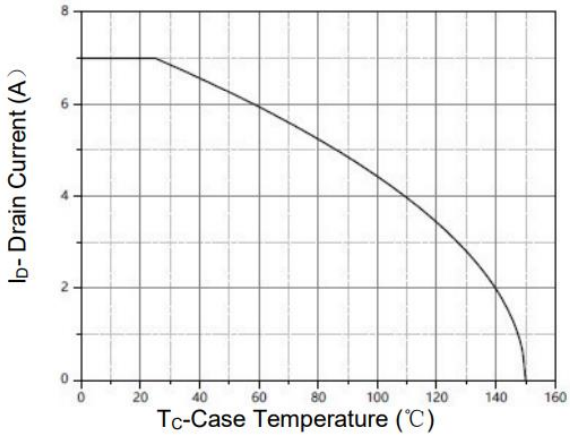


Figure 2. Drain Current

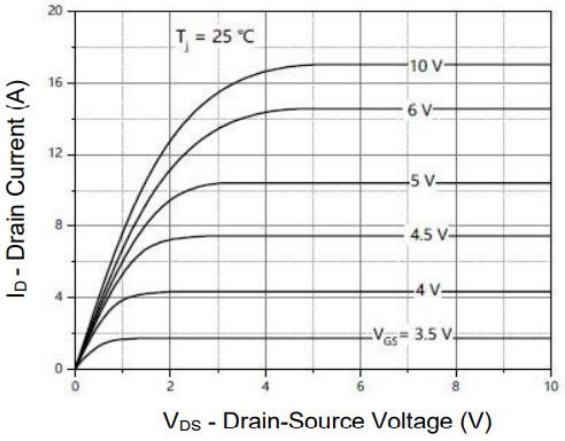


Figure 3. Output characteristics

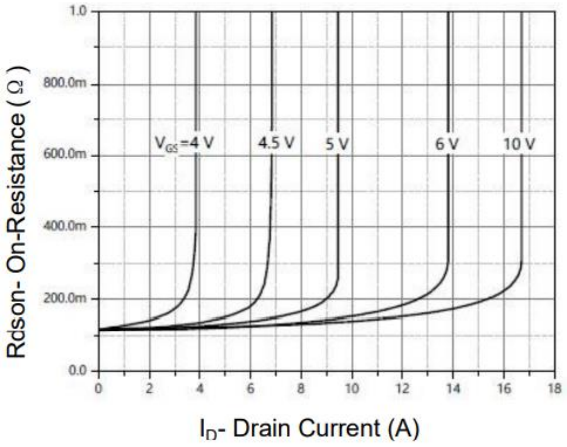


Figure 4. Drain-Source On-state resistance

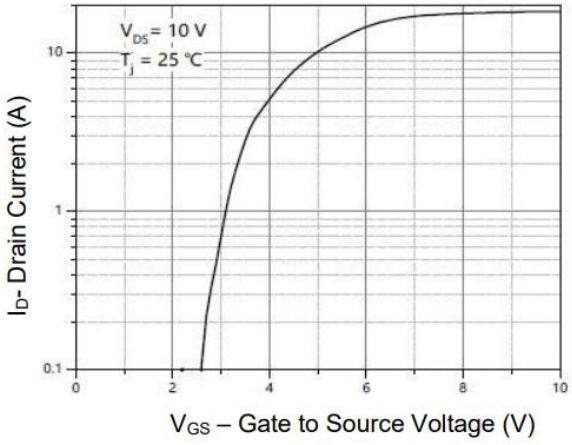


Figure 5. Transfer Characteristics

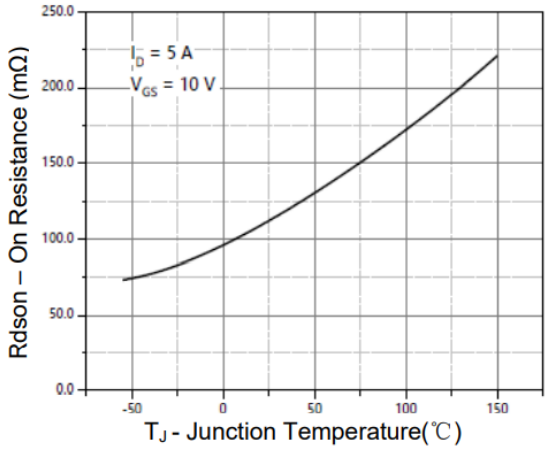


Figure 6. Drain-Source On-State Resistance

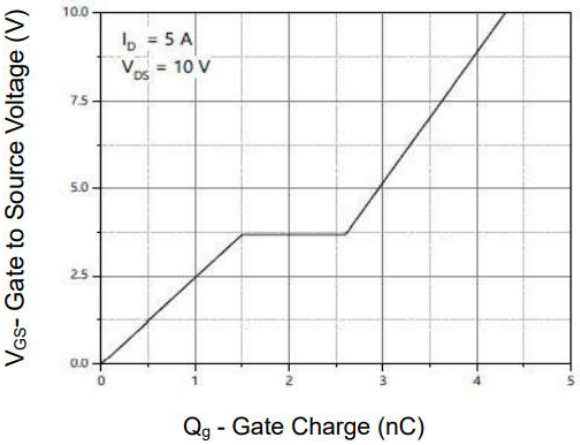


Figure 7. Gate Charge

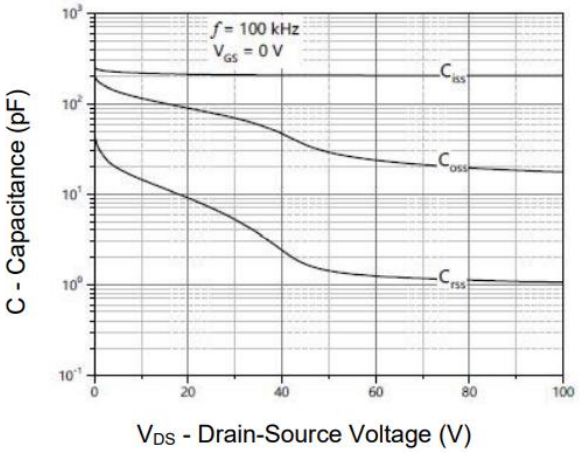


Figure 8. Capacitance vs Vds

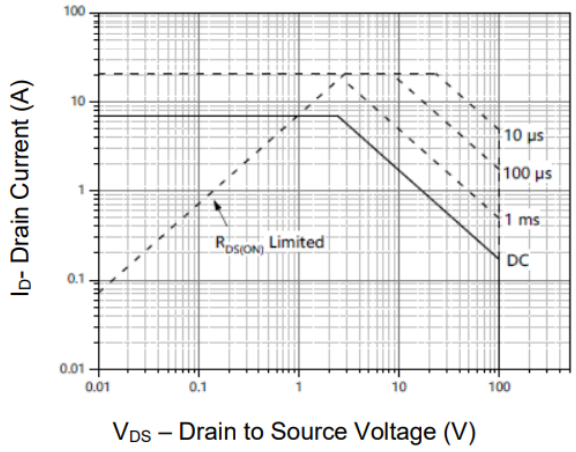


Figure 9. Safe Operation Area

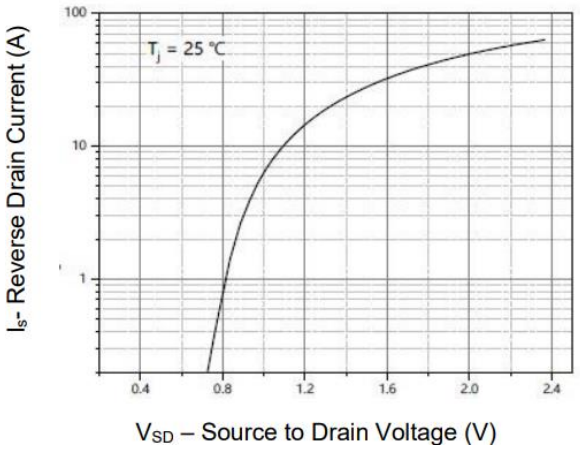


Figure 10. Source- Drain Diode Forward

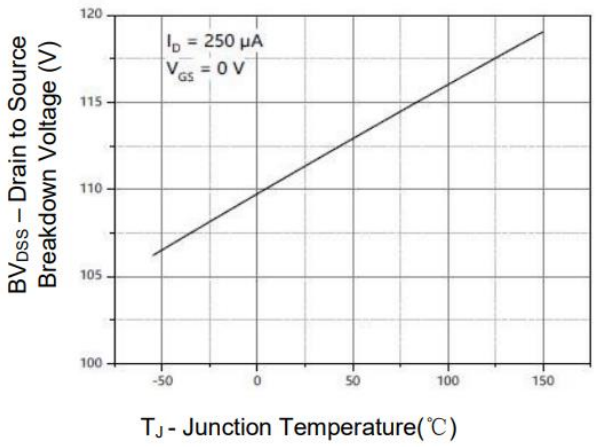
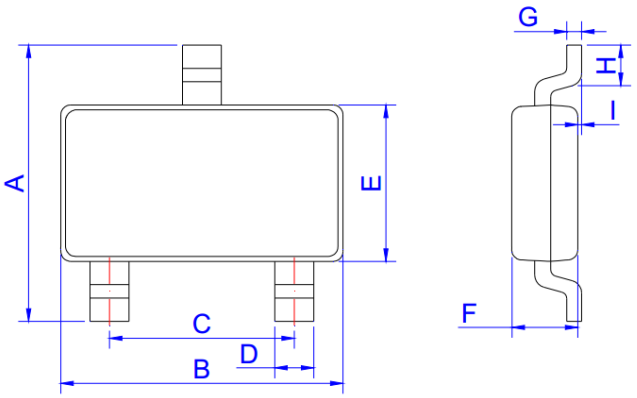


Figure 11. Drain-source breakdown voltage

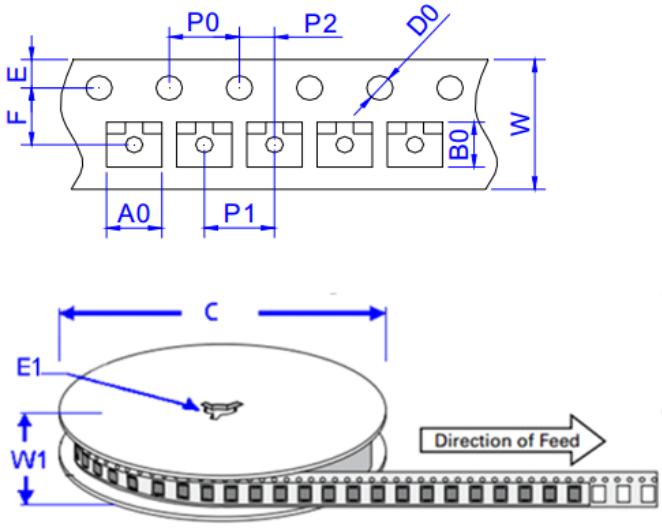
SOT-23 Package Mechanical Data



SOT-23

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.30	2.40	2.50	0.091	0.095	0.098
B	2.80	2.90	3.00	0.110	0.114	0.118
C	1.90 REF			0.075 REF		
D	0.35	0.40	0.45	0.014	0.016	0.018
E	1.20	1.30	1.40	0.047	0.051	0.055
F	0.90	1.00	1.10	0.035	0.039	0.043
G		0.10	0.15		0.004	0.006
H	0.20			0.008		
I	0		0.10	0		0.004

Package Information-SOT-23



Ref.	Dimensions	
	Millimeters	Inches
A0	3.15 ± 0.3	0.124 ± 0.012
B0	2.77 ± 0.3	0.109 ± 0.012
C	178	7.0
D0	1.50±0.1	0.059 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3±0.3	0.524± 0.012
F	3.5 ± 0.2	0.138 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	4.00 ± 0.2	0.157 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	8.00 ± 0.2	0.315 ± 0.008
W1	11.5±1.0	0.453 ± 0.039

Ordering Information-SOT-23

OUTLINE	PACKAGE TYPE	QUANTITY REEL	DESCIPTION
TAPING	SOT-23	3,000pcs	7 inch reel pack

NOTE:

1.We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.

2.Please do not exceed the absolute maximum ratings of the device when circuit designing.

3.Winsemi Microelectronics Co., Ltd reserved the right to make changes in this specification sheet and is subject to change without prior notice.

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